

# RJK0451DPB

40V, 35A, 7.0m $\Omega$  max. Silicon N Channel Power MOS FET Power Switching

#### Features

- High speed switching
- Capable of 4.5 V gate drive
- Low drive current
- High density mounting

R07DS0073EJ0200

Rev.2.00

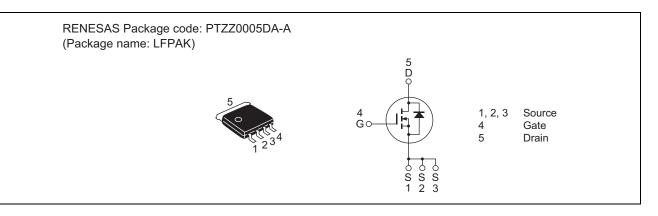
Apr 09, 2013

Low on-resistance

 $R_{DS(on)} = 5.5 \text{ m}\Omega \text{ typ.}$  (at  $V_{GS} = 10 \text{ V}$ )

- Pb-free
- Halogen-free

#### Outline



## Application

• Switching Mode Power Supply

## **Absolute Maximum Ratings**

			$(Ta = 25^{\circ}C)$	
ltem	Symbol	Ratings	Unit	
Drain to source voltage	V <sub>DSS</sub>	40	V	
Gate to source voltage	V <sub>GSS</sub>	±20	V	
Drain current	I <sub>D</sub>	35	A	
Drain peak current	I <sub>D(pulse)</sub> Note1	140	A	
Body-drain diode reverse drain current	I <sub>DR</sub>	35	A	
Avalanche current	I <sub>AP</sub> Note 2	17.5	A	
Avalanche energy	E <sub>AS</sub> Note 2	24.5	mJ	
Channel dissipation	Pch <sup>Note3</sup>	45	W	
Channel to Case Thermal Resistance	θch-C	2.78	°C/W	
Channel temperature	Tch	150	°C	
Storage temperature	Tstg	-55 to +150	٥C	

Notes: 1. PW  $\leq$  10  $\mu$ s, duty cycle  $\leq$  1%

2. Value at Tch = 25°C, Rg  $\geq$  50  $\Omega$ 

3. Tc = 25°C

This product is for the low voltage drive ( $\leq 10$ V).

If the driving voltage is over 10 V under normal conditions, please use the product for high gate to source cutoff voltage  $(V_{GS(off)})$  which characteristics has been improved.



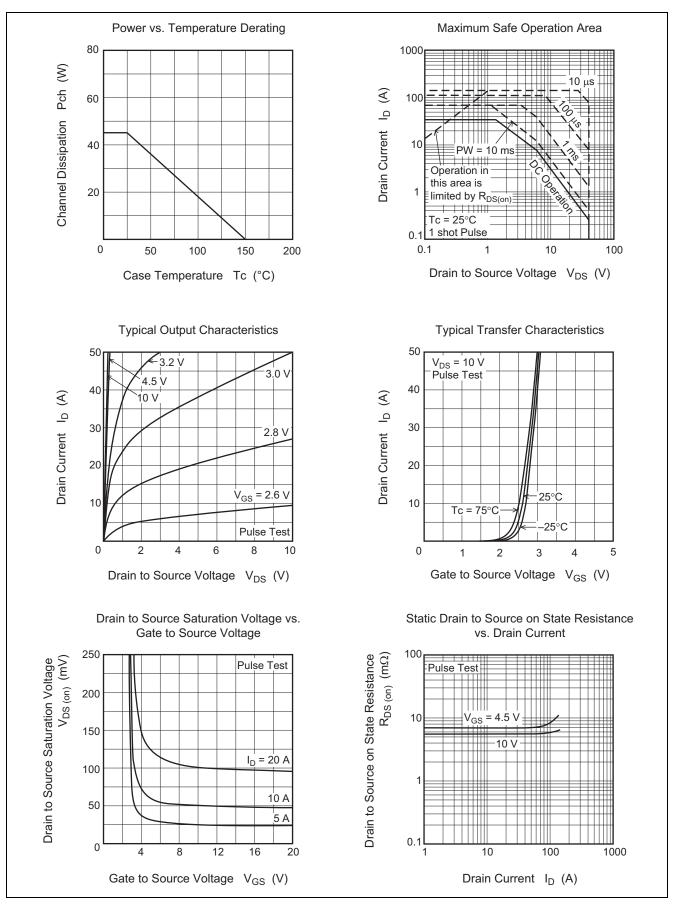
## **Electrical Characteristics**

ltem	Symbol	Min	Тур	Мах	Unit	(Ta = 25°C) Test Conditions	
	-	40	тур	IVIAN	V		
Drain to source breakdown voltage	V <sub>(BR)DSS</sub>	40			-	$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$	
Gate to source leak current	I <sub>GSS</sub>	—	—	±0.1	μA	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$	
Zero gate voltage drain current	I <sub>DSS</sub>	_	—	1	μA	$V_{DS} = 40 V, V_{GS} = 0 V$	
Gate to source cutoff voltage	V <sub>GS(off)</sub>	1.2	—	2.5	V	$V_{DS} = 10 V, I_D = 1 mA$	
Static drain to source on state	R <sub>DS(on)</sub>	—	5.5	7.0	mΩ	$I_D = 17.5 \text{ A}, V_{GS} = 10 \text{ V}^{\text{Note4}}$	
resistance	R <sub>DS(on)</sub>	_	7.0	9.6	mΩ	$I_D = 17.5 \text{ A}, V_{GS} = 4.5 \text{ V}^{Note4}$	
Forward transfer admittance	y <sub>fs</sub>	_	47	_	S	$I_D = 17.5 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note4}}$	
Input capacitance	Ciss	_	2010	_	pF	$V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ f = 1 MHz	
Output capacitance	Coss	_	330	_	pF		
Reverse transfer capacitance	Crss	_	140	_	pF		
Gate Resistance	Rg		0.7	_	Ω		
Total gate charge	Qg		14	_	nC	$V_{DD} = 10 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V},$ $I_D = 35 \text{ A}$	
Gate to source charge	Qgs		7.0	_	nC		
Gate to drain charge	Qgd		3.0	_	nC		
Turn-on delay time	t <sub>d(on)</sub>		13	_	ns		
Rise time	tr		4.8	_	ns		
Turn-off delay time	t <sub>d(off)</sub>		48	_	ns		
Fall time	t <sub>f</sub>		6.0	_	ns		
Body-drain diode forward voltage	$V_{DF}$		0.83	1.1	V	$I_F = 35 \text{ A}, V_{GS} = 0 \text{ V}^{Note4}$	
Body-drain diode reverse recovery	t <sub>rr</sub>	_	28	_	ns	$I_F = 35 \text{ A}, V_{GS} = 0 \text{ V}$	
time						di <sub>F</sub> / dt = 100 A/ μs	

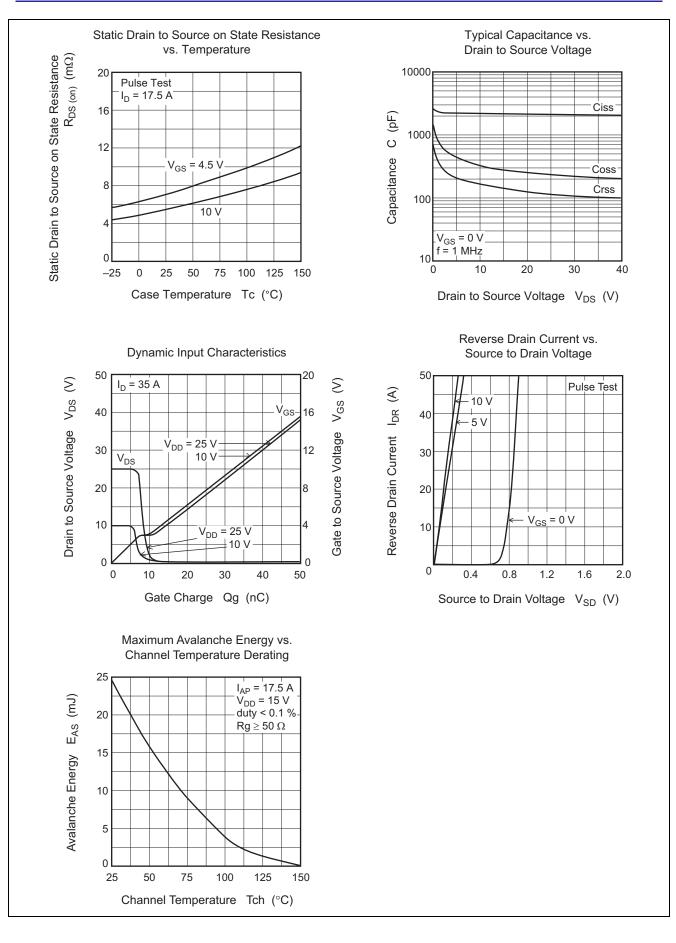
Notes: 4. Pulse test

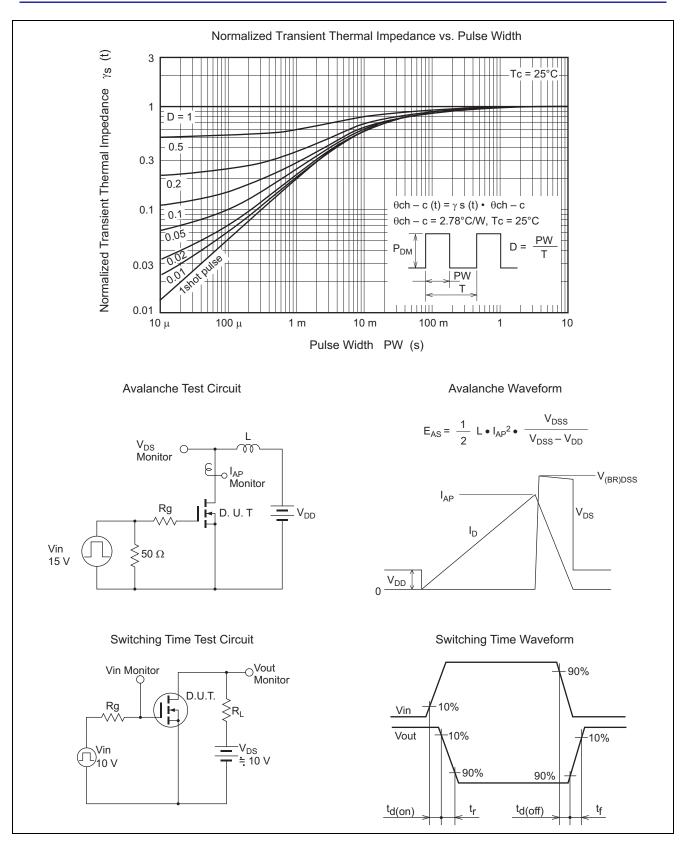


#### **Main Characteristics**



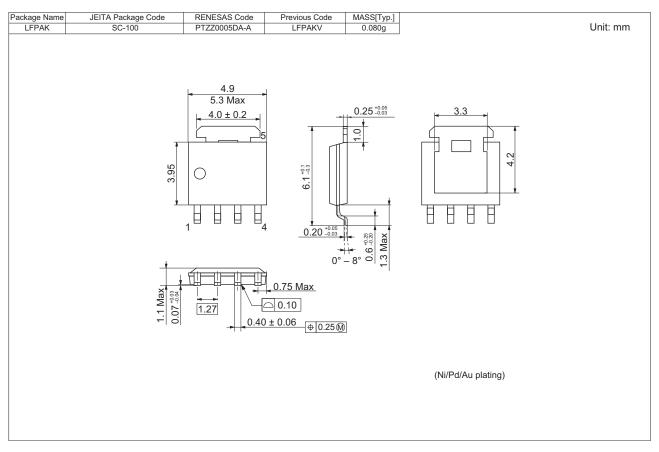








## **Package Dimensions**



#### **Ordering Information**

Part No.	Quantity	Shipping Container
RJK0451DPB-00-J5	2500 pcs	Taping



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